

General Description

The MY2074BGNE5 uses advanced trench technology MOSFETS to provide excellent $R_{DS(ON)}$ and low gate charge. The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

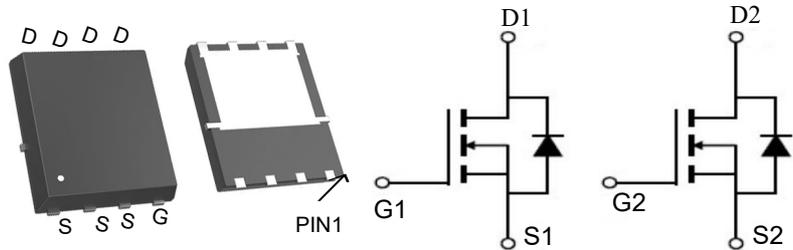


Features

V_{DSS}	20	-20	V
I_D	6	-3.8	A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	<20		m Ω
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	<25		m Ω
$R_{DS(ON)}$ (at $V_{GS}=-10V$)	<60		m Ω
$R_{DS(ON)}$ (at $V_{GS}=-4.5V$)	<75		m Ω

Application

- High density cell design
- Good stability and uniformity
- Good heat dissipation
- high ESD capability



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MY2074BGNE5	PDFN5*6-8L	NULL	5000

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETERS/ TEST CONDITIONS		SYMBOL	N-Channel	P-Channel	UNITS
Drain- Source Voltage		V_{DS}	20	-20	V
Gate- Source Voltage		V_{GS}	± 8	± 8	V
Continuous Drain Current	$T_A = 25^\circ\text{C}$	I_D	6	-3.8	A
	$T_A = 70^\circ\text{C}$		4.8	-3	
Pulsed Drain Current ¹		I_{DM}	20	-15	
Power Dissipation ³	$T_A = 25^\circ\text{C}$	P_D	1.9	1.9	W
	$T_A = 70^\circ\text{C}$		1.2	1.2	
Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150		$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	$t \leq 10s$	$R_{\theta JA}$	N-ch	63	$^\circ\text{C} / \text{W}$
			P-ch	63	
Junction-to-Ambient ²	Steady- State		N-ch	97	
			P-ch	97	

¹ Pulse width limited by maximum junction temperature.

² The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

³ The Power dissipation is based on $R_{\theta JA} t \leq 10s$ value.

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT	
			MIN	TYP	MAX		
STATIC							
Drain- Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250 μA	N-Ch	20			V
		V _{GS} = 0V, I _D = -250 μA	P-Ch	-20			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	N-Ch	0.5	0.7	1	V
		V _{DS} = V _{GS} , I _D = -250 μA	P-Ch	-0.3	-0.6	-1	
Gate- Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±8V	N-Ch			±100	nA
		V _{DS} = 0V, V _{GS} = ±8V	P-Ch			±100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 16V, V _{GS} = 0V	N-Ch			1	μA
		V _{DS} = - 16V, V _{GS} = 0V	P-Ch			-1	
		V _{DS} = 10V, V _{GS} = 0V, T _J = 55 °C	N-Ch			10	
		V _{DS} = - 10V, V _{GS} = 0V, T _J = 55 °C	P-Ch			-10	
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 4.5V, I _D = 5A	N-Ch		25	30	mΩ
		V _{GS} = -4.5V, I _D = -2.5A	P-Ch		60	75	
		V _{GS} = 2.5V, I _D = 4.5A	N-Ch		29	38	
		V _{GS} = -2.5V, I _D = -2A	P-Ch		73	90	
		V _{GS} = 1.8V, I _D = 2A	N-Ch		36	55	
		V _{GS} = - 1.8V, I _D = - 1A	P-Ch		91	125	
Forward Transconductance ¹	g _{fs}	V _{DS} = 10V, I _D = 5A	N-Ch		26		S
		V _{DS} = - 10V, I _D = -2.5A	P-Ch		10		
DYNAMIC							
Input Capacitance	C _{iss}	N-Channel	N-Ch		510		pF
			P-Ch		588		
Output Capacitance	C _{oss}	V _{GS} = 0V, V _{DS} = 10V, f = 1MHz	N-Ch		83		pF
			P-Ch		82		
Reverse Transfer Capacitance	C _{rss}	V _{GS} = 0V, V _{DS} = - 10V, f = 1MHz	N-Ch		67		pF
			P-Ch		61		
Gate Resistance	R _g	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz	N-Ch		1.9		Ω
			P-Ch		7.4		

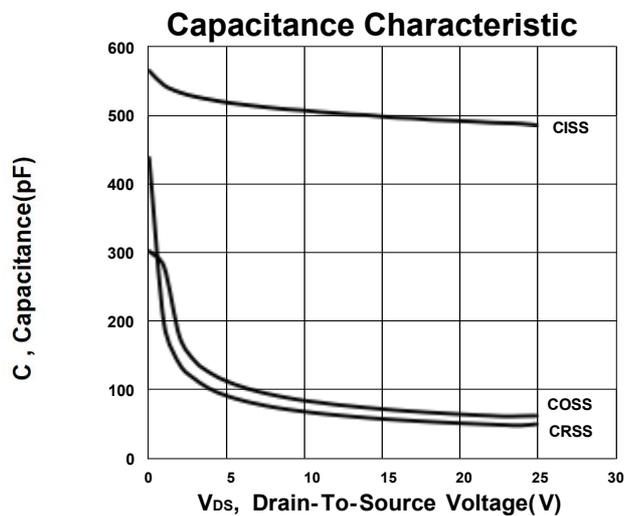
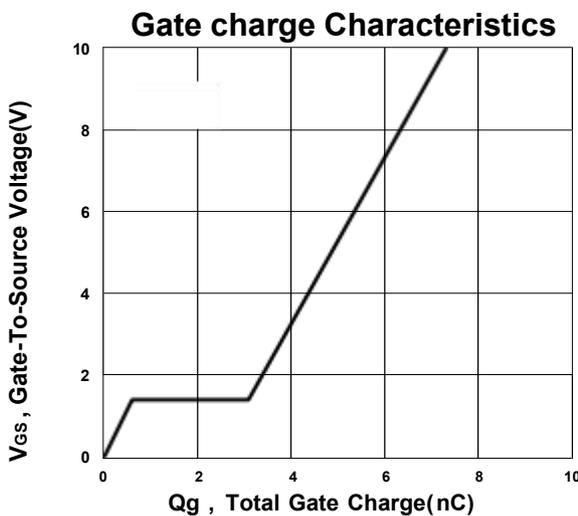
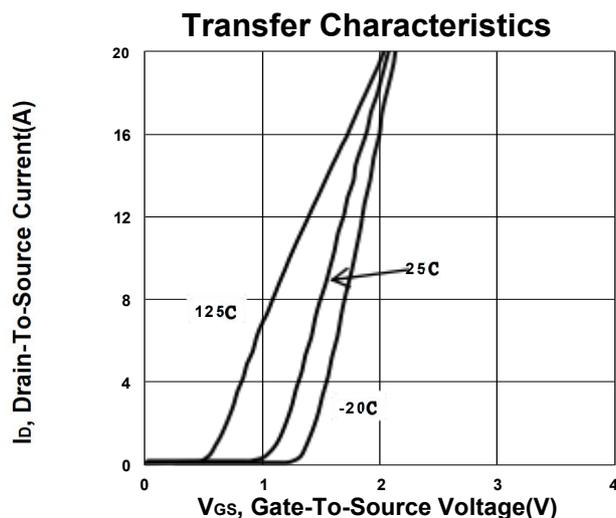
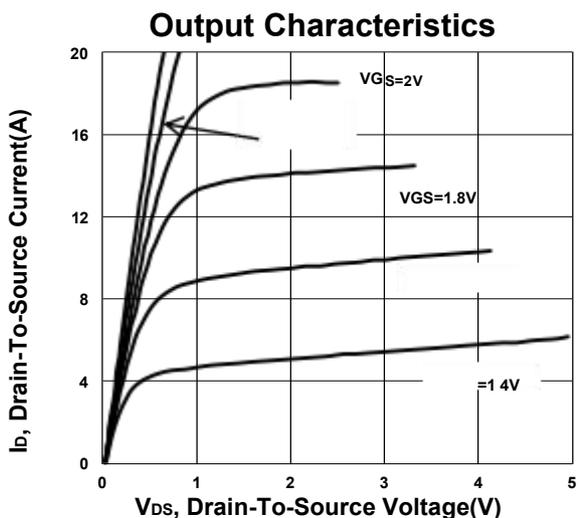
Typical Characteristics

Total Gate Charge ²	Q_g	N-Channel $V_{DS} = 10V, V_{GS} = 4.5V, I_D = 5A$ P-Channel $V_{DS} = -10V, V_{GS} = -4.5V, I_D = -2.5A$	N-Ch	7.3	nC	
Gate-Source Charge ²	Q_{gs}		P-Ch	7.3		
Gate-Drain Charge ²	Q_{gd}		N-Ch	0.6		
			P-Ch	0.7		
			N-Ch	2.5		
			P-Ch	1.9		
Turn-On Delay Time ²	$t_{d(on)}$	N- Channel $V_{DS} = 10V,$ $I_D = 5A, V_{GS} = 4.5V, R_{GEN} = 6\Omega$ P- Channel $V_{DS} = -10V,$ $I_D = -2.5A, V_{GS} = -4.5V,$ $R_{GEN} = 6\Omega$	N-Ch	11	nS	
Rise Time ²	t_r		P-Ch	8.2		
Turn-Off Delay Time ²	$t_{d(off)}$		N-Ch	94		
Fall Time ²	t_f		P-Ch	33		
			N-Ch	26		
			P-Ch	43		
			N-Ch	69		
			P-Ch	54		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$)						
Continuous Current	I_S		N-Ch		1.9	A
			P-Ch		-1.6	
Forward Voltage ¹	V_{SD}	$I_F = 5A, V_{GS} = 0V$	N-Ch		1	V
		$I_F = -2.5A, V_{GS} = 0V$	P-Ch		-1.2	
Reverse Recovery Time	t_{rr}	$I_F = 5A, di_F/dt = 100A / \mu s$ $I_F = -2.5A, di_F/dt = 100A / \mu s$	N-Ch	9	nS	
			P-Ch	10		
Reverse Recovery Charge	Q_{rr}		N-Ch	3	nC	
			P-Ch	3		

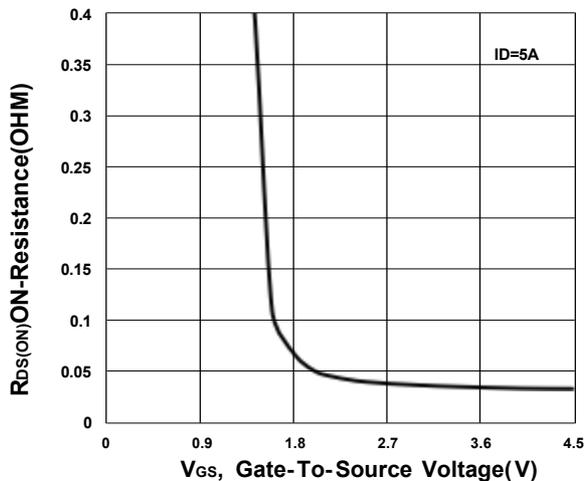
¹ Pulse test : Pulse Width $\leq 300\text{ }\mu\text{sec}$, Duty Cycle $\leq 2\%$.

² Independent of operating temperature.

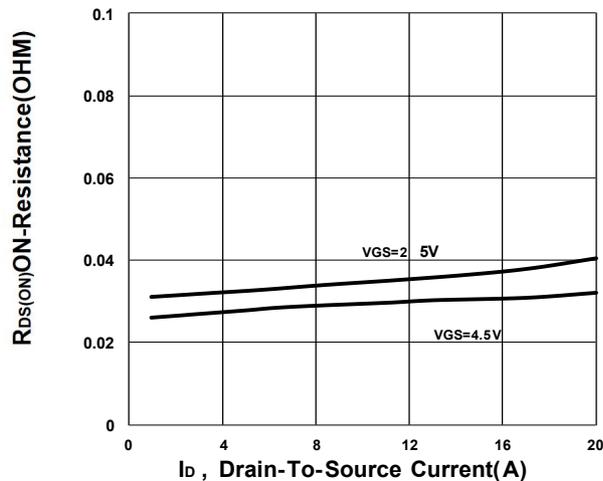
TYPICAL 'PERFORMANCE' CHARACTERISTICS 'N-CHANNEL

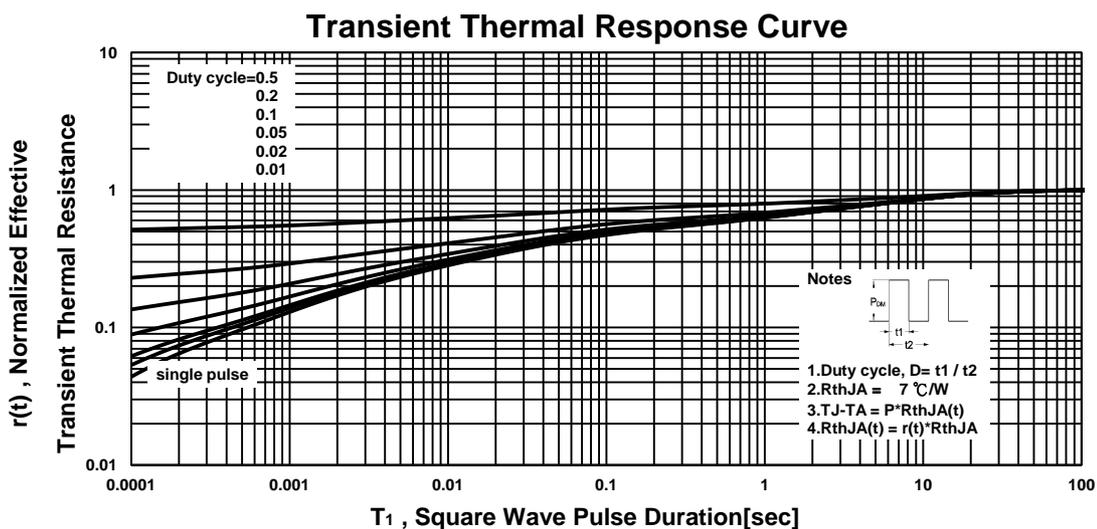
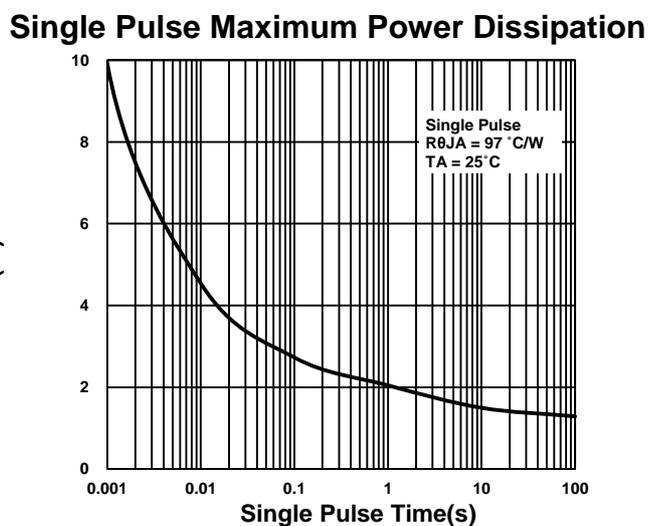
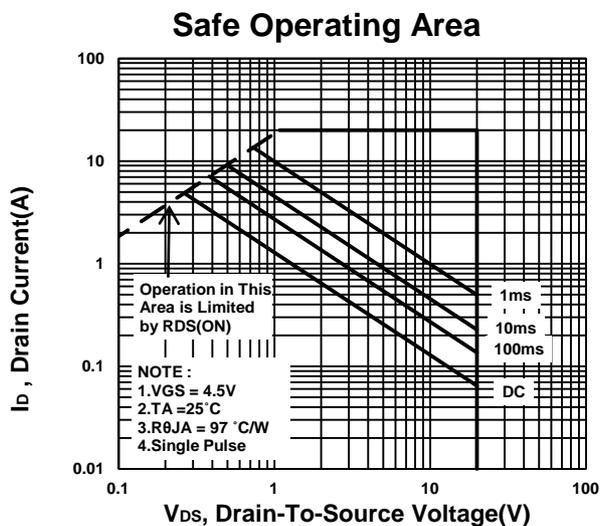
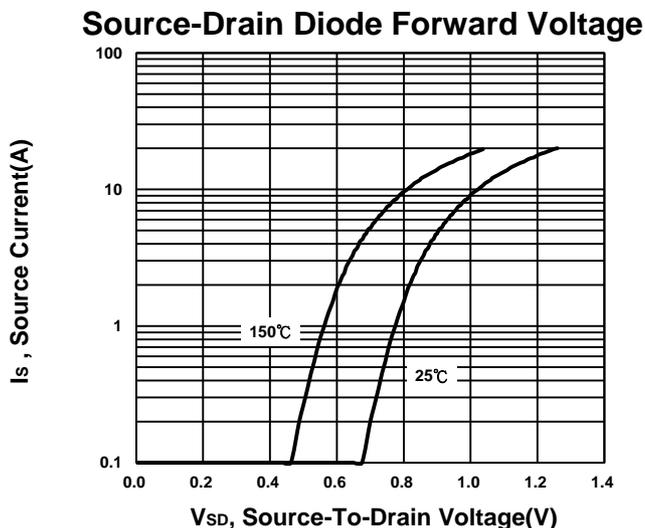
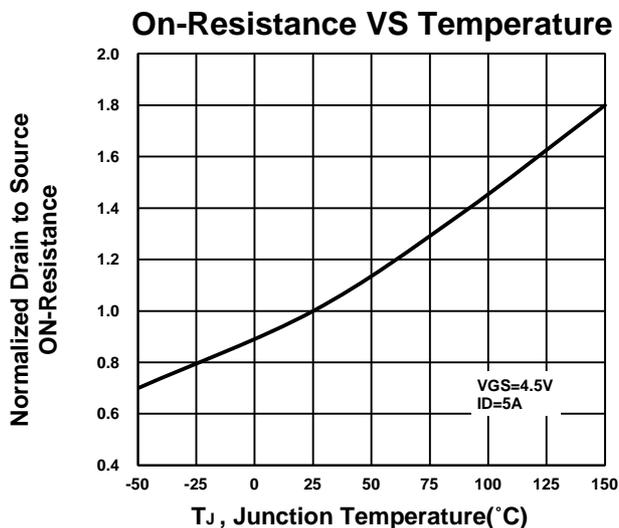


On-Resistance VS Gate-To-Source Voltage



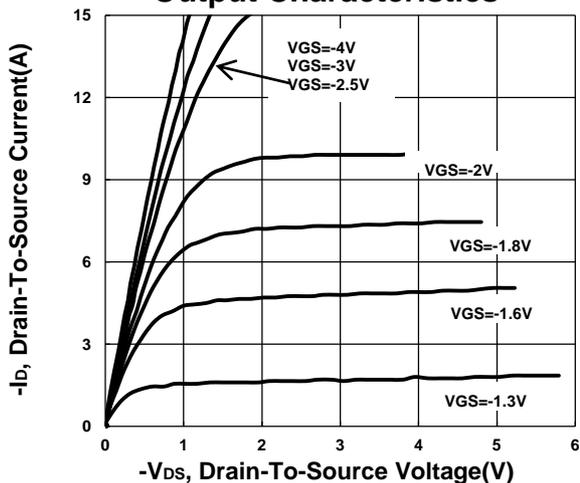
On-Resistance VS Drain-To-Source Current



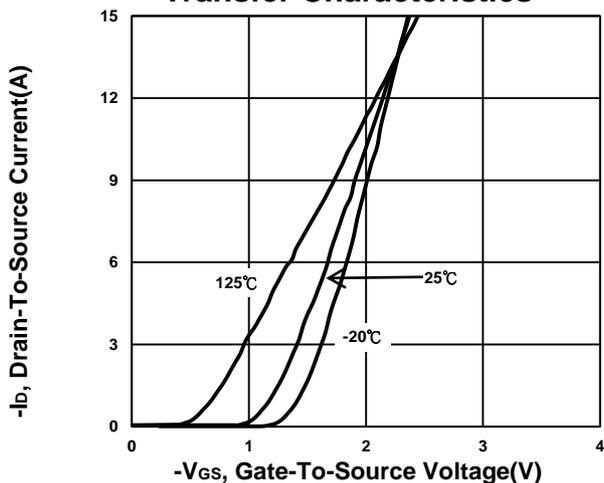


P-CHANNEL

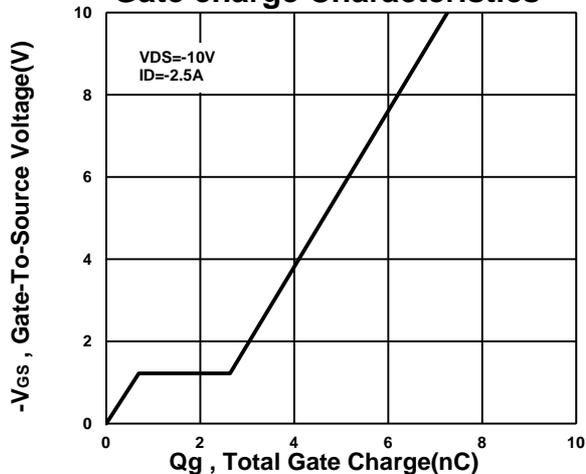
Output Characteristics



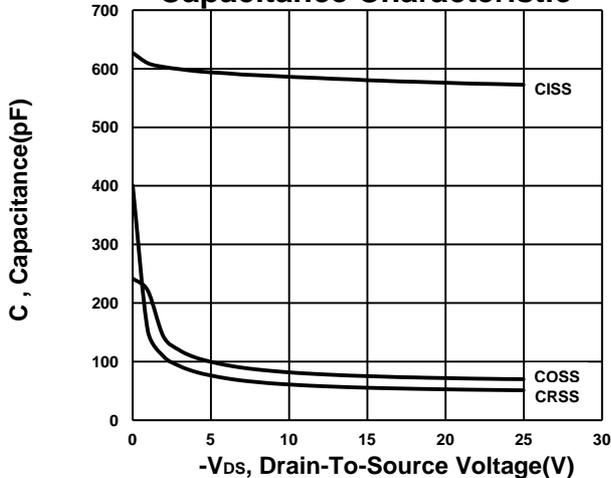
Transfer Characteristics



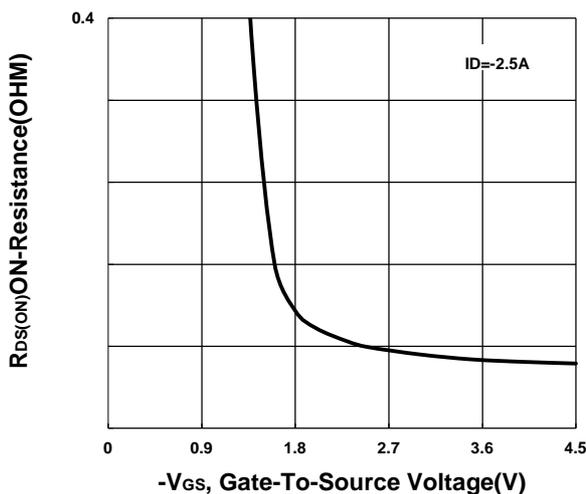
Gate charge Characteristics



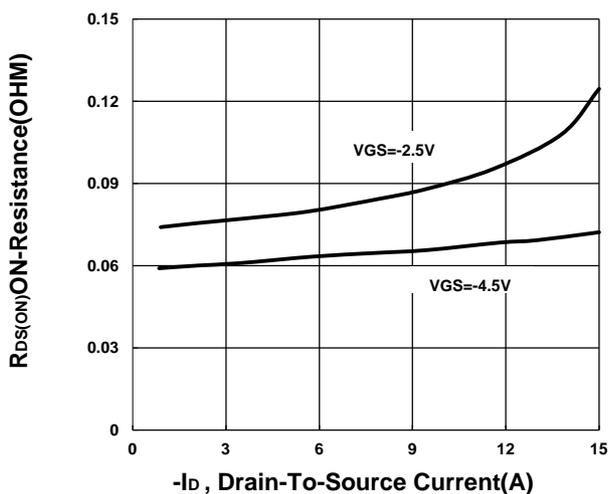
Capacitance Characteristic

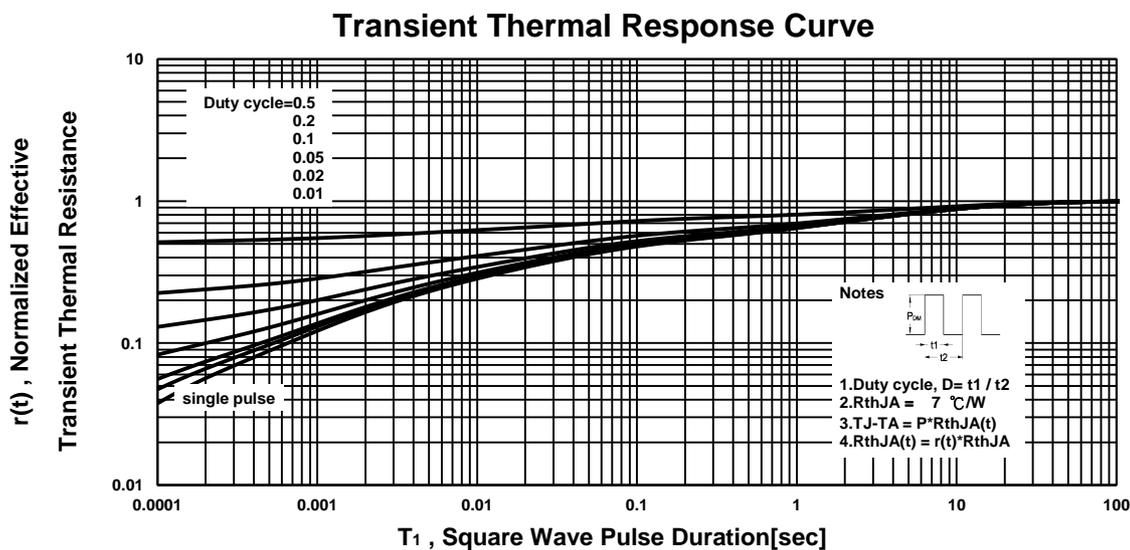
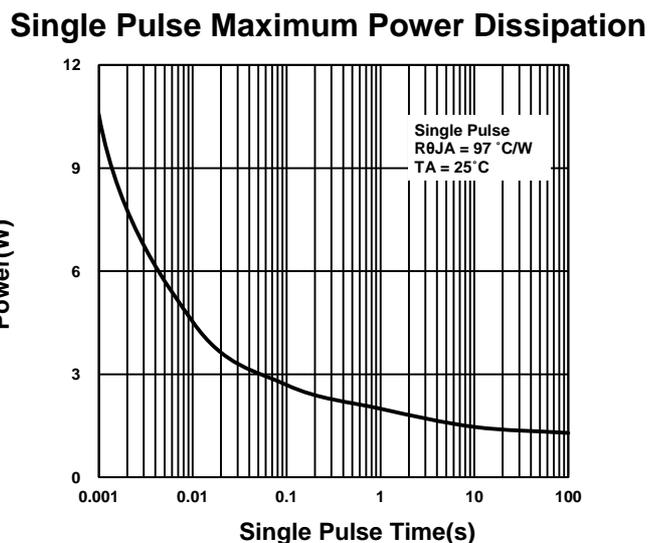
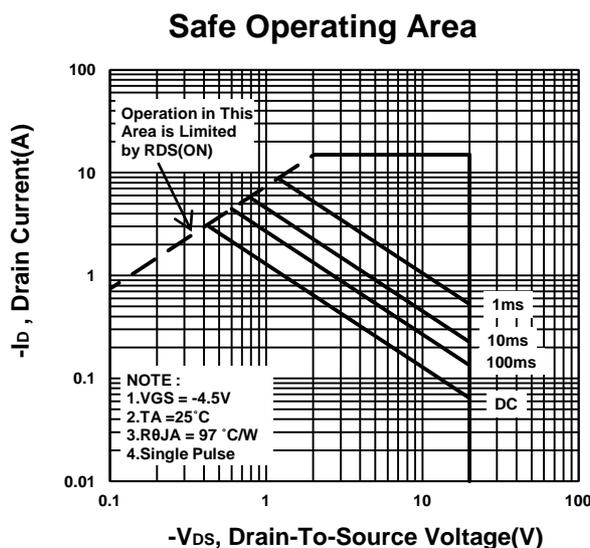
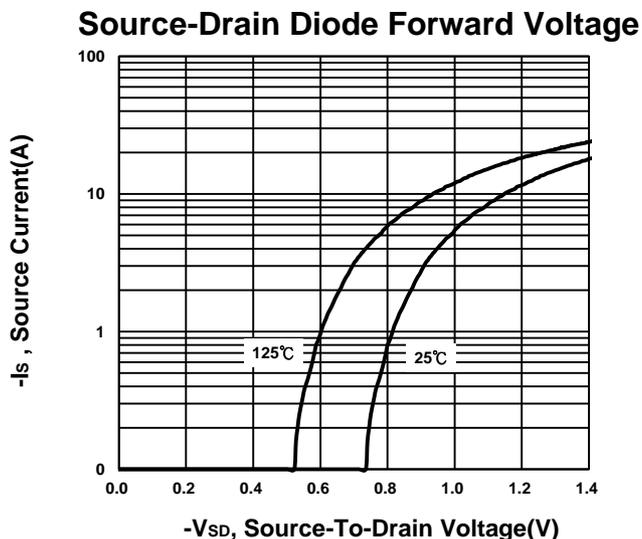
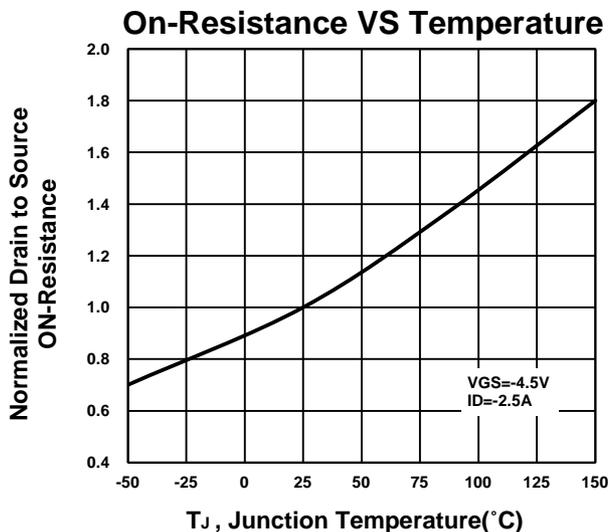


On-Resistance VS Gate-To-Source Voltage

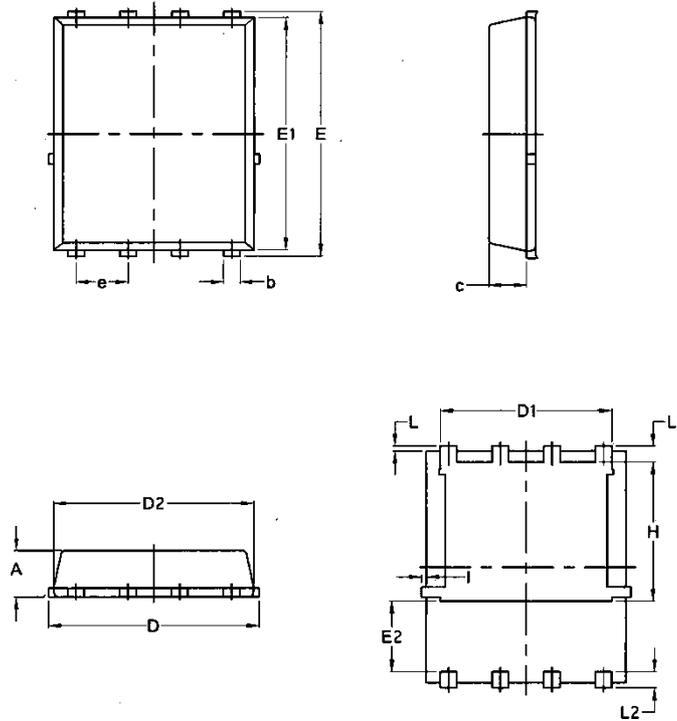


On-Resistance VS Drain-To-Source Current





Package Mechanical Data-DFN5*6-8L-JQ Single



Symbol	Common			
	mm		Inch	
	Min	Max	Min	Max
A	1.03	1.17	0.0406	0.0461
b	0.34	0.48	0.0134	0.0189
c	0.824	0.0970	0.0324	0.082
D	4.80	5.40	0.1890	0.2126
D1	4.11	4.31	0.1618	0.1697
D2	4.80	5.00	0.1890	0.1969
E	5.95	6.15	0.2343	0.2421
E1	5.65	5.85	0.2224	0.2303
E2	1.60	/	0.0630	/
e	1.27 BSC		0.05 BSC	
L	0.05	0.25	0.0020	0.0098
L1	0.38	0.50	0.0150	0.0197
L2	0.38	0.50	0.0150	0.0197
H	3.30	3.50	0.1299	0.1378
I	/	0.18	/	0.0070